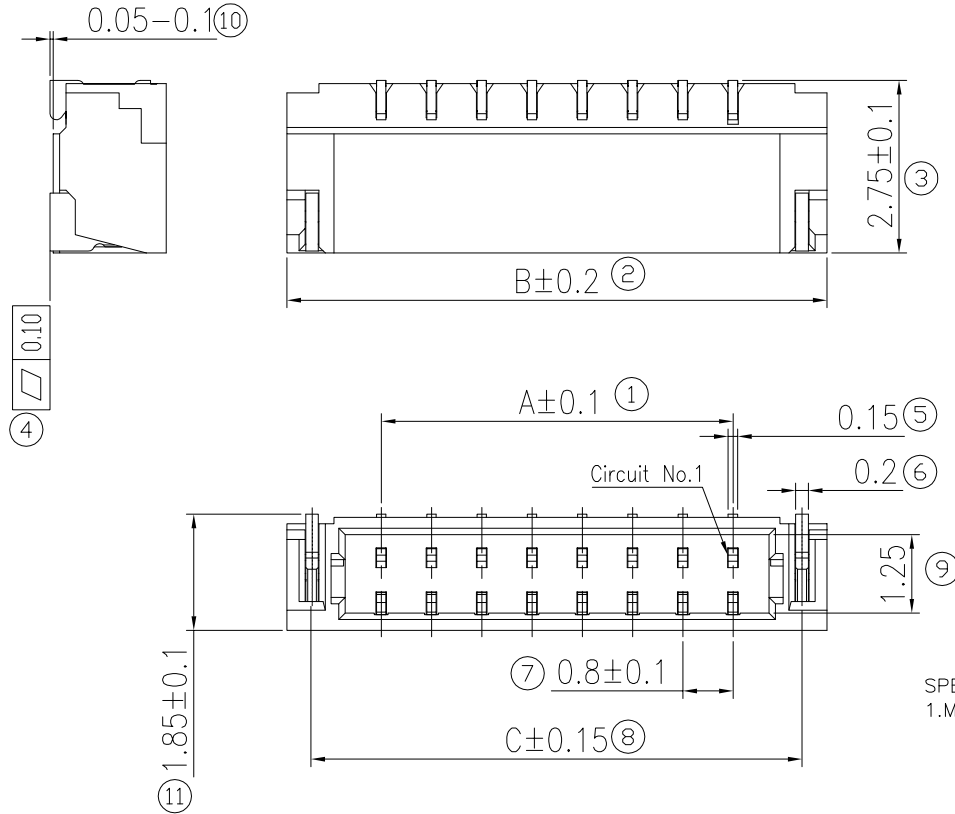


5	6	7	8
REV.	DATE	ECN NO.	MODIFICATION
A	20181022	/	NEW
APPROVER			
JASON			



SPECIFICATION

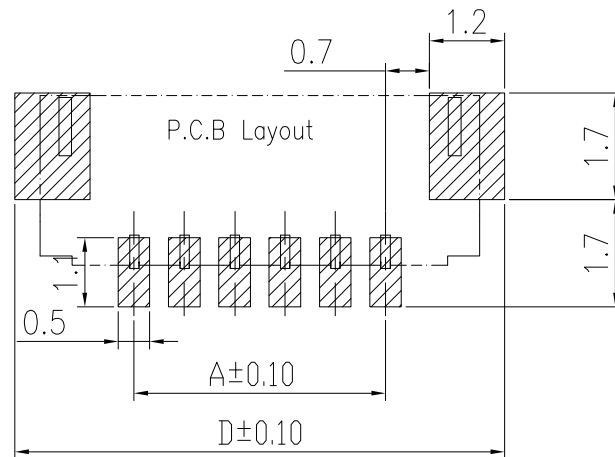
1.Material:

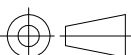
Housing: Thermoplastic, UL94V-0,color:Natural .
Terminal: copper alloy.
Solder_Tab: copper alloy.
TIN/GOLD PLATED OVER NICKEL PLATED (50 U" MIN)
Solder tab: copper alloy.
TIN/GOLD PLATED OVER NICKEL PLATED

2.Electrical Characteristics:

Voltage rating: DC,30V(50HZ) .
Current rating : 0.2A,DC(AWG#36) 0.5A,DC(AWG#32)
1.0A,DC(AWG#28铜线)
Operating Temperature: $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$.
Insulation resistance: 100M ohms min. at 200VDC
Dielectric withstanding voltage: 200V AC/1minute.
Contact resistance: 20m ohms max.

极数	尺寸				备注
	A	B	C	D	
2	0.80	3.80	3.00	4.60	
3	1.60	4.60	3.80	5.40	
4	2.40	5.40	4.60	6.20	
5	3.20	6.20	5.40	7.00	
6	4.00	7.00	6.20	7.80	
7	4.80	7.80	7.00	8.60	
8	5.60	8.60	7.80	9.40	
9	6.40	9.40	8.60	10.20	
10	7.20	10.20	9.40	11.00	
11	8.00	11.00	10.20	11.80	
12	8.80	11.80	11.00	12.60	
13	9.60	12.60	11.80	13.40	
14	10.40	13.40	12.60	14.20	
15	11.20	14.20	13.40	15.00	
16	12.00	15.00	14.20	15.80	
17	12.80	15.80	15.00	16.60	
18	13.60	16.60	15.80	17.40	
19	14.40	17.40	16.60	18.20	
20	15.20	18.20	17.40	19.00	
21	16.00	19.00	18.20	19.80	
22	16.80	19.80	19.00	20.60	



GENERAL TOLERANCE					UNITS mm	NAME:	ATOM [®] 深圳市爱特姆科技有限公司 SHENZHEN ATOM TECHNOLOGY CO.,LTD.			
SELECT	✓					WAFER				
TOL. ON.	1	2	3		MAT'L	PART NO:	TITLE:Customer Drawing For Wafer0.8mm XP SMT 贴片			
X.XXX		±0.05	±0.15		FINISH	APPD:	Jason	DWG NO. ATOM-A04169		
X.XX	±0.05	±0.13	±0.25			CHKD:	ABEL	 SCALE: 1:1 SHEET: 1/1 REV: A		
X.X	±0.15	±0.25	±0.50			Q'TY				
X.	±0.20	±0.38	±1.00			DR:	tom			
ANGLE	±2°									



SCALE	SHEET	REV
1:1	1/1	A